

Harvatek Surface Mount CHIP LEDs Data Sheet B3DJ3BGR-05C000113U1930

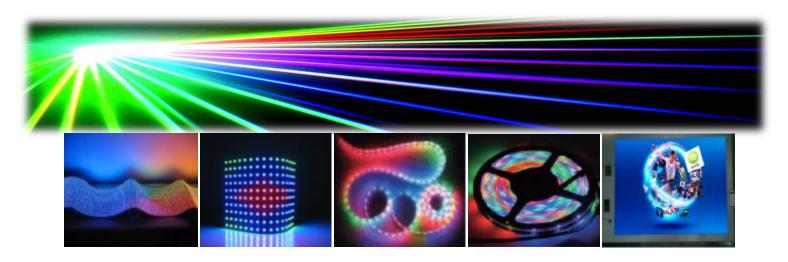
(Preliminary)

Features

- •Support control circuit to be integrated with RGB chips into a single package
- •Support signal reshaping to pass control waveforms to next adjacent ALED.
- •Cascading port transmission by a single data line
- •Support BI backup input data line to prevent data input failure from malfunction DI line
- •Optional- Optional maximal drive current: 5mA
- •256-step gray-scale output to allow 16,777,216 color display
- •Support 18-level current gain control for R/G/B channels
- •Support sleep and wake up mode (patent granted)
- •Built-in power-on-reset (1.7V) (@VDD=5V)
- •Built-in brown-out reset (1.8V) (@VDD=5V)
- •Operating voltage 3.3~5.5V

Applications

- Gaming keyboard
- Decorative LED lighting
- LED video display



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Product Specifications

Specification	Material	Quantity
Red : 40~120 mcd		
Green : 60~180 mcd		
Blue : 15~60 mcd		
IC@5V, R/G/B@5mA		
Ts= 25° C; Tolerance ±10%		
Red : 618~630 nm		
Green : 518~535 nm		
Blue : 460~472 nm		
IC@5V, R/G/B@5mA		
Ts= 25° C; Tolerance ±10%		
5V_DC		
120°		
Clear	Ероху	
	Conductive black tape	3000 ea/reel
	Conductive black	
HT standard	Paper	
250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
HT standard	Paper	Non-specified
	Red: 40~120 mcd Green: 60~180 mcd Blue: 15~60 mcd IC@5V, R/G/B@5mA Ts= 25° C; Tolerance ±10% Red: 618~630 nm Green: 518~535 nm Blue: 460~472 nm IC@5V, R/G/B@5mA Ts= 25° C; Tolerance ±10% 5V_DC 120° Clear HT standard 250x230mm	Red: 40~120 mcd Green: 60~180 mcd Blue: 15~60 mcd IC@5V, R/G/B@5mA Ts= 25° C; Tolerance ±10% Red: 618~630 nm Green: 518~535 nm Blue: 460~472 nm IC@5V, R/G/B@5mA Ts= 25° C; Tolerance ±10% SV_DC 120° Clear Epoxy Conductive black tape Conductive black HT standard Paper 250x230mm Aluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note: This is shipped test conditions

*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

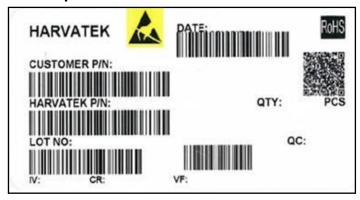
be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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Label Specifications



Harvatek P/N:

B 3DJ 3 BGR- 05C- 0001 13

Product	Package	Dice Q'ty	Color	Current	Series Number	Taping
РСВ	2.0(L)x2.0(W)x0.9(H) mm	3:Tri	RGB	R/G/B:5mA	X001~XZZZ	1.Taping style
			RGB(Full Color)			2. Q'ty

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	Α	2	2	L	1	2
Cod	de 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	В
Internal Tr	racing Code	2020-L 2021-M 2022-P 2023-Q 2026-T 2027-V 2030-Y 2031-Z	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000~ZZZ	

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Specifications Range

■Luminous Intensity (Iv) :

Color Spec. Range		
R	40-120 mcd	
G	60-180 mcd	
В	15-60 mcd	

Note: It maintains a tolerance of ±10% on luminous intensity

■Wavelength:

Color	Spec. Range
R	618-630 nm
G	518-535 nm
В	460-472 nm

Note: It maintains a tolerance of $\pm 0.5 \text{nm}$ on Wavelength Bin

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Product Features

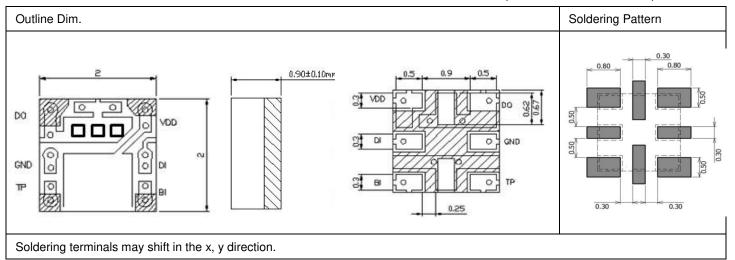
Electro-Optical Characteristics

(T_{Soldering}, 25 °C)

1	(Soldering, 25							
Corios	Fraitting Color Material		Wavelength λ(nm)			I _V (mcd)	Viewing	
Series	Emitting Color	Material	λ_{D}	λ_{P}	Δλ	Typical	Angle $2\theta \frac{1}{2}$	
	R	AllnGaP	620	629	18	65	120	
B3DJ3GRB	G	InGaN	523	518	35	85	120	
	В	InGaN	464	460	25	20	120	

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)



Absolute Maximum Ratings

(T_{Soldering} 25 °C)

Characteristic	Symbol	Rating	Unit
Supply Voltage	VDD	6.5	٧
Power Dissipation	PD	<40	mW
Maximum Output Current	ILEDOUT	6	mA
Welding Temperature	TM	300(8S)	°C
Operating Temperature Range	TOPR	-25~85	°C
Storage Temperature Range	TSTO	-65~120	°C

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Electrical Characteristics

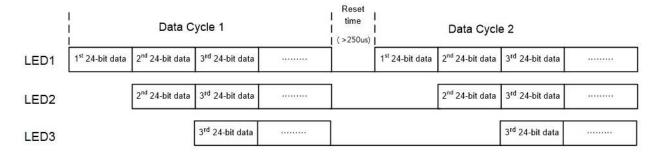
Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Supply Voltage	VDD	3.3	5	5.5	V	
Operation Current	I _{DD}		1		mA	R, G, B no load
Sleep Mode Current	l _{sleep}		5			
Input High "H" of DI, BI	V _{IH}	0.7*VDD		VDD+0.4	V	
Input Low "L" of DI, BI	V_{IL}	-0.4		0.2*VDD	V	
Output High "H" of DO	V _{OH}	4.5			V	I _{OH} =3mA
Output Low "L" of DO	V _{OL}			0.4	V	I _{oL} =3mA
R , G , B Sink Current	I _{SINK}	4.75	5	5.25	mA	Max. 5mA option
R/G/B Current Gain			5/17		mA/level	Max. 5mA option
DI, BI Input leakage	l _{leak}			1	uA	V _{DI} =V _{BI} =VDD=5V
R, G, B off leakage	-			1		PWM=0(off),
current	I _{off}			1	uA	@R, G, B =5V

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Propagation	tPLZ			80	ns	
delay time	tPZL			80	ns	
Rising time	tTHL		15		ns	DI → DO, load=30pF
Falling time	tTLH		15		ns	
Rising time	tR		50		ns	ICV/D/C/D) - Em A load-20nE
Falling time	tF		50		ns	ISK(R/G/B) =5mA, load=30pF
Data rate	F_{data}		800		KHz	

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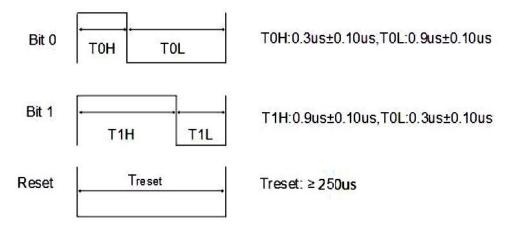
Data Transfer Protocol



The single wire data transfer protocol supports 24-bit data for each LED RGB display data refresh. The IC receives 24-bit data and passes the remaining data to next LED. The 24-bit data consist of green, red and blue data, each with 8-bit width, and are transferred with MSB first.



The transferred data are recognized based on the pulse widths received by the IC. A low bit 0 is represented by a 0.3us high pulse followed by a 0.9us low pulse. A high bit 1 is represented by a 0.9us high pulse followed by a 0.3us low pulse. A low pulse \geq 200us is used to issue a reset command to the IC to start a new cycle of serial commands.



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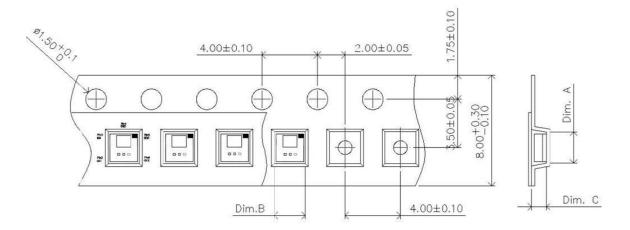
Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 72 hours after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

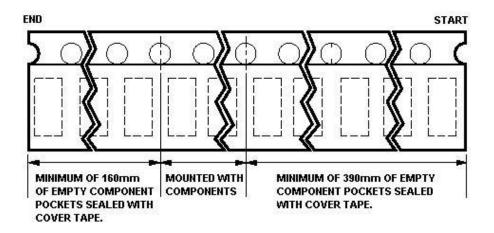
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Packaging Tape Dimension



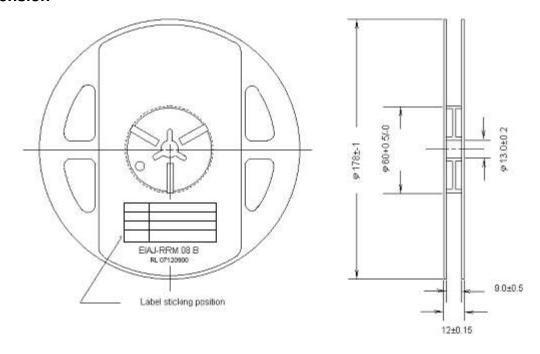
Dim. A	Dim. B	Dim. C	Q'ty/Reel
2.15±0.10	2.15±0.10	1.05±0.10	3K



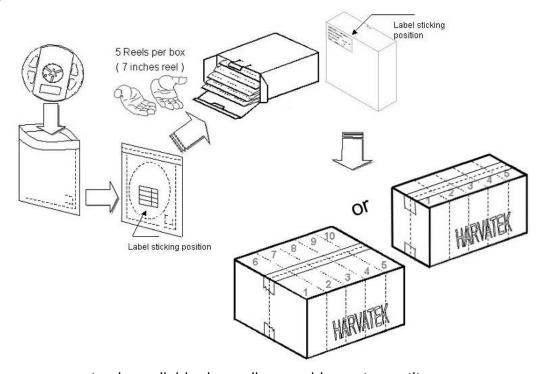
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Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

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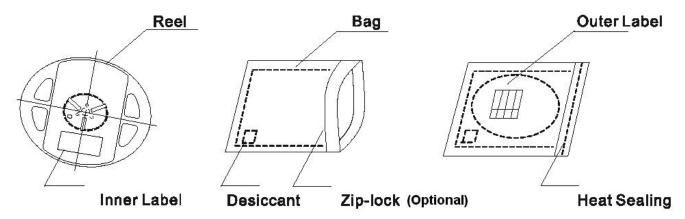


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 72 hours. The conditions are as followings:

- 1. $60\pm3^{\circ}$ C × $(12\sim24\text{hrs})$ and <5% RH, taped reel type.
- 2. $100\pm3^{\circ}$ C × (45min~1hr), bulk type.
- 3. $130\pm3^{\circ}$ C ×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

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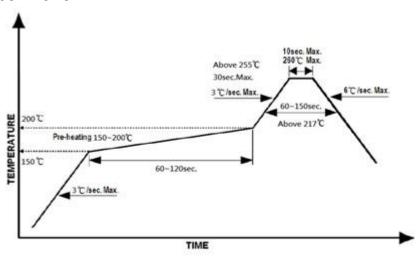


Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 217°C ,60~150 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^oC max, <3min

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Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
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